

Surface Mount Fast Switching Rectifier

RS2A thru RS2K

Vishaymas General Semiconductor



DO-214AA (SMB)

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated chip junction
- Fast switching for high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see www.vishaymas.com

TYPICAL APPLICATIONS

For use in fast switching rectification of power supply, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

PRIMARY CHARACTERISTICS	
I _{F(AV)}	1.5 A
V _{RRM}	50 V to 800 V
I _{FSM}	50 A
t _{rr}	150 ns, 250 ns, 500 ns
V _F	1.3 V
T _J max.	150 °C

MECHANICAL DATA

Case: DO-214AA (SMB)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)								
PARAMETER	SYMBOL	RS2A	RS2B	RS2D	RS2G	RS2J	RS2K	UNIT
Device marking code		RA	RB	RD	RG	RJ	RK	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	500	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	V
Maximum average forward rectified current at T _L = 100 °C	I _{F(AV)}	1.5						A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	50						A
Operating junction and storage temperature range	T _J , T _{STG}	- 55 to + 150						°C

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)										
PARAMETER	TEST CONDITIONS		SYMBOL	RS2A	RS2B	RS2D	RS2G	RS2J	RS2K	UNIT
Maximum instantaneous forward voltage	1.5 A		V_F	1.3						V
Maximum DC reverse current at rated DC blocking voltage		$T_A = 25^\circ\text{C}$	I_R	5.0						μA
		$T_A = 125^\circ\text{C}$		200						
Maximum reverse recovery time	$I_F = 0.5 \text{ A}$, $I_R = 1.0 \text{ A}$, $I_{rr} = 0.25 \text{ A}$		t_{rr}	150			250	500	ns	
Typical junction capacitance	4.0 V, 1 MHz		C_J	20			17			pF

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)									
PARAMETER	SYMBOL	RS2A	RS2B	RS2D	RS2G	RS2J	RS2K	UNIT	
Typical thermal resistance	$R_{\theta JA}^{(1)}$	55							$^\circ\text{C/W}$
	$R_{\theta JL}^{(1)}$	18							

Note

(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.27" x 0.27" (7.0 mm x 7.0 mm) copper pad

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
RS2J-M3/52T	0.096	52T	750	7" diameter plastic tape and reel
RS2J-M3/5BT	0.096	5BT	3200	13" diameter plastic tape and reel

RATINGS AND CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

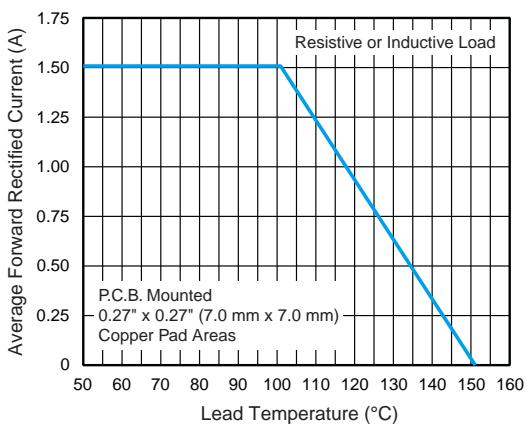


Fig. 1 - Forward Current Derating Curve

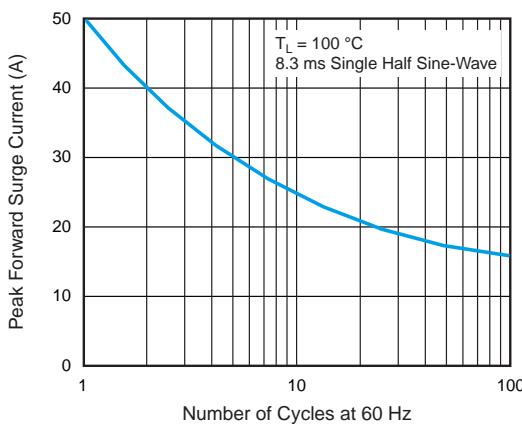


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

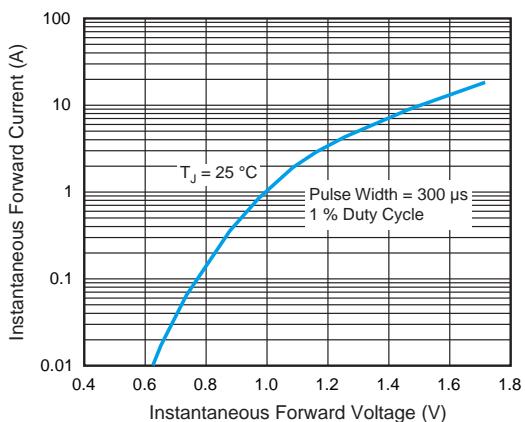


Fig. 3 - Typical Instantaneous Forward Characteristics

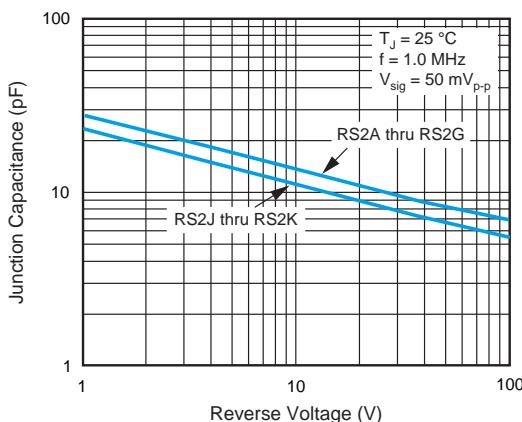


Fig. 5 - Typical Junction Capacitance

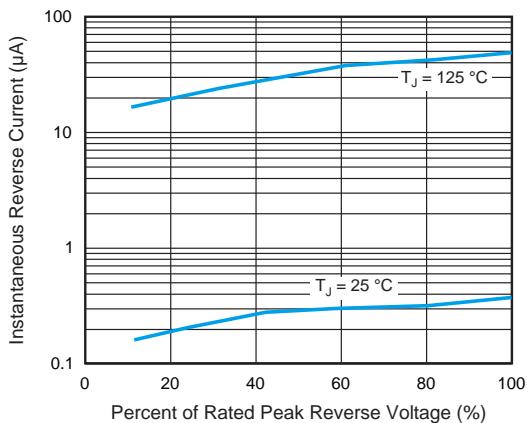
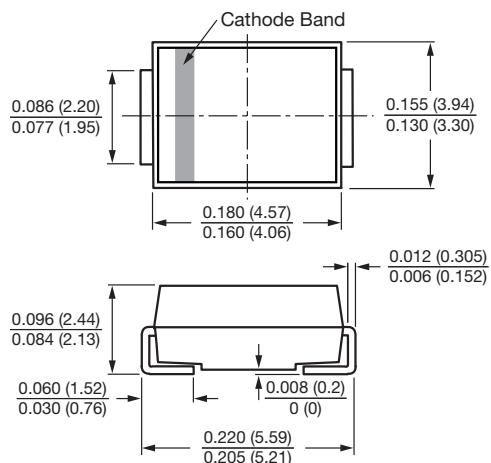


Fig. 4 - Typical Reverse Characteristics

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AA (SMB)



Mounting Pad Layout

